# 2SD1820A

#### Silicon NPN epitaxial planar type

#### For general amplification Complementary to 2SB1219A

#### Features

- Low collector-emitter saturation voltage  $V_{CE(sat)}$
- S-Mini type package, allowing downsizing of the equipment and automatic insertion through the tape packing.
- Package • Code
  - SMini3-G1
- Pin Name
  - 1. Base
  - 2. Emitter
- 3. Collector

Marking Symbol: X

Absolute Maximum Ratings  $T_a = 25^{\circ}C$ 

| Parameter                             | Symbol           | Rating      | Unit |
|---------------------------------------|------------------|-------------|------|
| Collector-base voltage (Emitter open) | V <sub>CBO</sub> | 60          | V    |
| Collector-emitter voltage (Base open) | V <sub>CEO</sub> | 50          | V    |
| Emitter-base voltage (Collector open) | V <sub>EBO</sub> | 5           | V    |
| Collector current                     | I <sub>C</sub>   | 500         | mA   |
| Peak collector current                | I <sub>CP</sub>  | 1           | А    |
| Collector power dissipation           | P <sub>C</sub>   | 150         | mW   |
| Junction temperature                  | Tj               | 150         | °C   |
| Storage temperature                   | T <sub>stg</sub> | -55 to +150 | °C   |
|                                       |                  |             |      |

#### Electrical Characteristics $T_a = 25^{\circ}C \pm 3^{\circ}C$

| Parameter   | Symbol                    | Conditions   | Min | Тур  | Max  | Unit |
|---|---------------------------|--|-----|------|------|------|
| Collector-base voltage (Emitter open)                               | V <sub>CBO</sub>          | $I_{\rm C} = 10 \ \mu {\rm A}, I_{\rm E} = 0$                      | 60  |      |      | V    |
| Collector-emitter voltage (Base open)                               | V <sub>CEO</sub>          | $I_{\rm C} = 2  {\rm mA}, I_{\rm B} = 0$                           | 50  | 9    |      | V    |
| Emitter-base voltage (Collector open)                               | V <sub>EBO</sub>          | $I_{\rm E} = 10 \ \mu A, I_{\rm C} = 0$                            | 5   |      |      | V    |
| Collector-base cutoff current (Emitter open)                        | I <sub>CBO</sub>          | $V_{CB} = 20 \text{ V}, I_E = 0$                                   | 1.1 |      | 0.1  | μΑ   |
| Forward current transfer ratio *1                                   | h <sub>FE1</sub> *2       | $V_{CE} = 10 \text{ V}, I_C = 150 \text{ mA}$                      | 85  |      | 340  |      |
|   | h <sub>FE2</sub>          | $V_{CE} = 10 \text{ V}, I_C = 500 \text{ mA}$                      | 40  |      |      |      |
| Collector-emitter saturation voltage *1                             | V <sub>CE(sat)</sub>      | $I_{\rm C} = 300 \text{ mA}, I_{\rm B} = 30 \text{ mA}$            |     | 0.35 | 0.60 | V    |
| Transition frequency  | $\mathbf{f}_{\mathrm{T}}$ | $V_{CB} = 10 \text{ V}, I_E = -50 \text{ mA}, f = 200 \text{ MHz}$ |     | 200  |      | MHz  |
| Collector output capacitance<br>(Common base, input open circuited) | C <sub>ob</sub>           | $V_{CB} = 10 \text{ V}, I_E = 0, f = 1 \text{ MHz}$                |     | 6    | 15   | pF   |

Note) 1. Measuring methods are based on JAPANESE INDUSTRIAL STANDARD JIS C 7030 measuring methods for transistors.

2. \*1: Pulse measurement

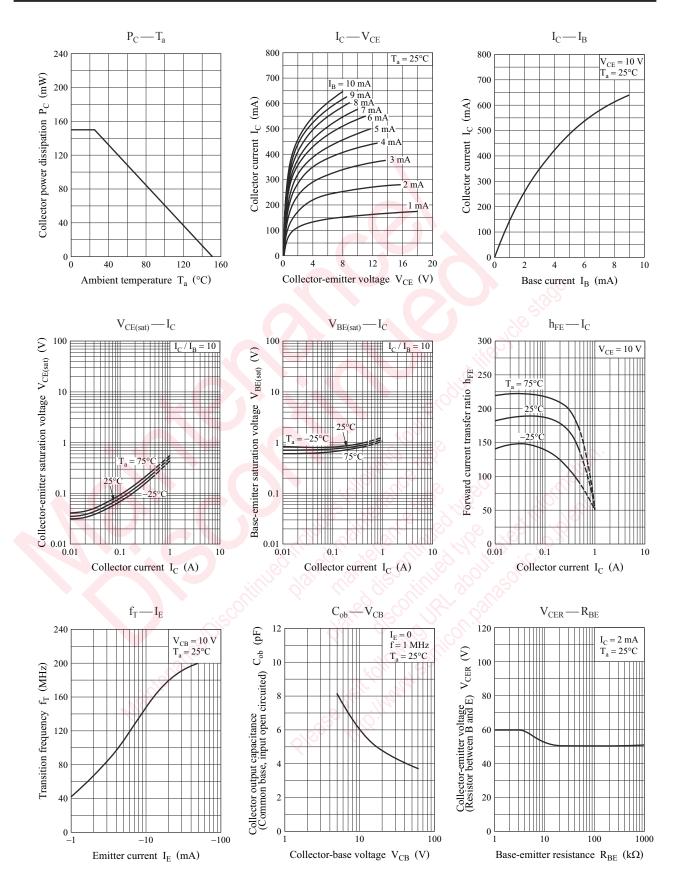
\*2: Rank classification

| Rank           | Q         | R          | S          | No-rank   |
|----------------|-----------|------------|------------|-----------|
| $h_{\rm FE1}$  | 85 to 170 | 120 to 240 | 170 to 340 | 85 to 340 |
| Marking symbol | XQ        | XR         | XS         | Х         |

Product of no-rank is not classified and have no marking symbol for rank.

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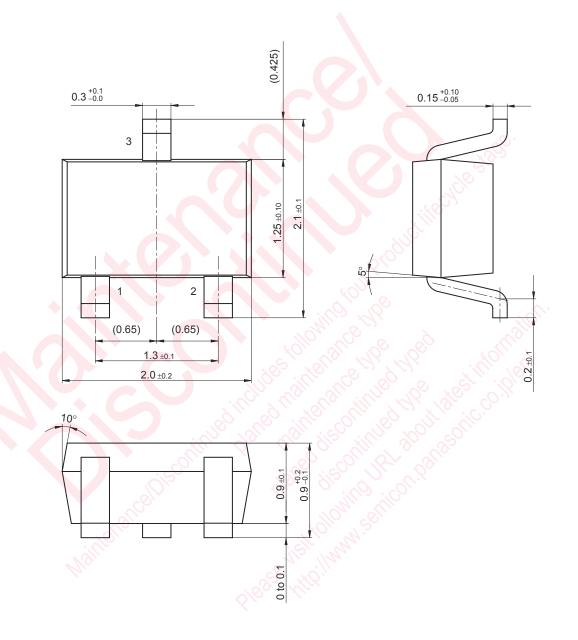
### Panasonic



### Panasonic

SMini3-G1

Unit: mm



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